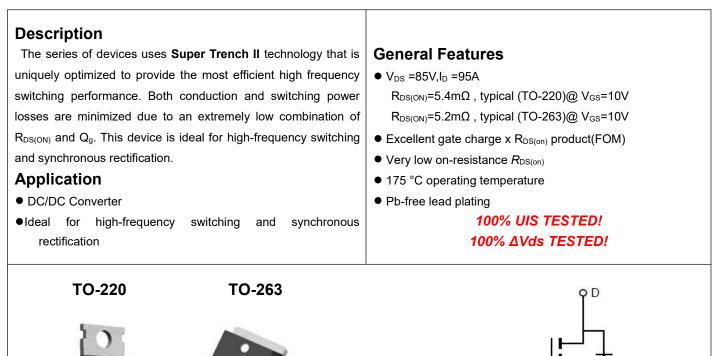


## NCE N-Channel Super Trench II Power MOSFET



## Package Marking and Ordering Information

- actuage martin		.g			
Device Marking	Device	Device Package	Reel Size	Tape width	Quantity
NCEP058N85M	NCEP058N85M	TO-220	-	-	-
NCEP058N85MD	NCEP058N85MD	TO-263	-	-	-

### Absolute Maximum Ratings (Tc=25°C unless otherwise noted)

Parameter	Symbol	Limit	Unit
Drain-Source Voltage	VDS	85	V
Gate-Source Voltage	Vgs	±20	V
Drain Current-Continuous	I <sub>D</sub>	95	A
Drain Current-Continuous(Tc=100 ℃)	I <sub>D</sub> (100℃)	72	A
Pulsed Drain Current	I <sub>DM</sub>	380	A
Maximum Power Dissipation	PD	125	W
Derating factor		0.83	W/℃
Single pulse avalanche energy (Note 5)	E <sub>AS</sub>	599	mJ
Operating Junction and Storage Temperature Range	TJ,TSTG	-55 To 175	°C

G

**Schematic Diagram** 



### **Thermal Characteristic**

Thermal Resistance, Junction-to-Case <sup>(Note 2)</sup>	R <sub>θJC</sub>	1.2	°C <b>/W</b>
Thermal Resistance, Junction-to-Ambient <sup>(Note 2)</sup>	R <sub>0JA</sub>	60	°C <b>/W</b>

#### Electrical Characteristics (Tc=25°C unless otherwise noted)

Parameter	Symbol	Condition		Min	Тур	Мах	Unit
Off Characteristics	· · ·			·			
Drain-Source Breakdown Voltage	BV <sub>DSS</sub>	V <sub>GS</sub> =0V I <sub>D</sub> =250µA		85		-	V
Zero Gate Voltage Drain Current	I <sub>DSS</sub>	V <sub>DS</sub> =85V,V <sub>GS</sub> =0V		-	-	1	μA
Gate-Body Leakage Current	Igss	V <sub>GS</sub> =±20V,V <sub>D</sub>	os=0V	-	-	±100	nA
On Characteristics (Note 3)	I						1
Gate Threshold Voltage	V <sub>GS(th)</sub>	V <sub>DS</sub> =V <sub>GS</sub> ,I <sub>D</sub> =2	50µA	2.0	3.0	4.0	V
	5	V <sub>GS</sub> =10V, I <sub>D</sub> =45A	TO-220	-	5.4	5.8	mΩ
Drain-Source On-State Resistance	R <sub>DS(ON)</sub>		TO-263		5.2	5.8	mΩ
Forward Transconductance	<b>g</b> fs	V <sub>DS</sub> =5V,I <sub>D</sub> =45A			60	-	S
Dynamic Characteristics (Note4)	I						L
Input Capacitance	Clss	- V <sub>DS</sub> =40V,V <sub>GS</sub> =0V, - F=1.0MHz		-	3550	-	PF
Output Capacitance	Coss			-	540	-	PF
Reverse Transfer Capacitance	Crss			-	22	-	PF
Switching Characteristics (Note 4)	I						
Turn-on Delay Time	t <sub>d(on)</sub>			-	14.5	-	nS
Turn-on Rise Time	tr	V <sub>DD</sub> =40V,I <sub>D</sub> =45A V <sub>GS</sub> =10V,R <sub>G</sub> =1.6Ω		-	12	-	nS
Turn-Off Delay Time	t <sub>d(off)</sub>			-	35	-	nS
Turn-Off Fall Time	t <sub>f</sub>			-	13	-	nS
Total Gate Charge	Qg	V <sub>DS</sub> =40V,I <sub>D</sub> =45A, V <sub>GS</sub> =10V		-	67	-	nC
Gate-Source Charge	Q <sub>gs</sub>			-	20		nC
Gate-Drain Charge	Q <sub>gd</sub>			-	20		nC
Drain-Source Diode Characteristics	I						
Diode Forward Voltage (Note 3)	V <sub>SD</sub>	V <sub>GS</sub> =0V,I <sub>S</sub> =45A		-		1.2	V
Diode Forward Current (Note 2)	ls			-	-	95	Α
Reverse Recovery Time	t <sub>rr</sub>	T <sub>J</sub> = 25°C, I <sub>F</sub>	= Is	-	66	-	nS
Reverse Recovery Charge	Qrr	di/dt = 100A/µs <sup>(Note3)</sup>		-	140	-	nC

Notes:

1. Repetitive Rating: Pulse width limited by maximum junction temperature.

2. The value of  $R_{0JA}$  is measured with the device mounted on 1in2 FR-4 board with 2oz. Copper, in a still air environment with  $T_A = 25^{\circ}$  C. The Power dissipation <sub>PDSM</sub> is based on R <sub>0JA</sub> and the maximum allowed junction temperature of 150° C. The value in any given application depends on the user's specific board design, and the maximum temperature of 175° C may be used if the PCB allows it.

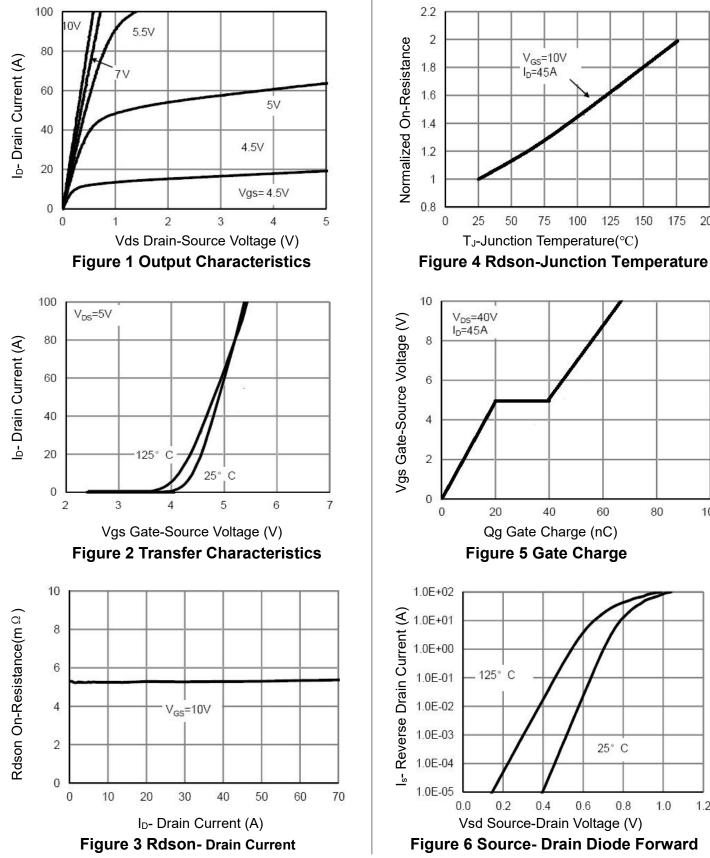
3. Pulse Test: Pulse Width  $\leq$  300µs, Duty Cycle  $\leq$  2%.

4. Guaranteed by design, not subject to production

5. EAS condition : Tj=25  $^{\circ}$ C,V<sub>DD</sub>=40V,V<sub>G</sub>=10V,L=0.5mH,Rg=25 $\Omega$ 







1.2

1.0

175

200

100



# NCEP058N85M, NCEP058N85MD

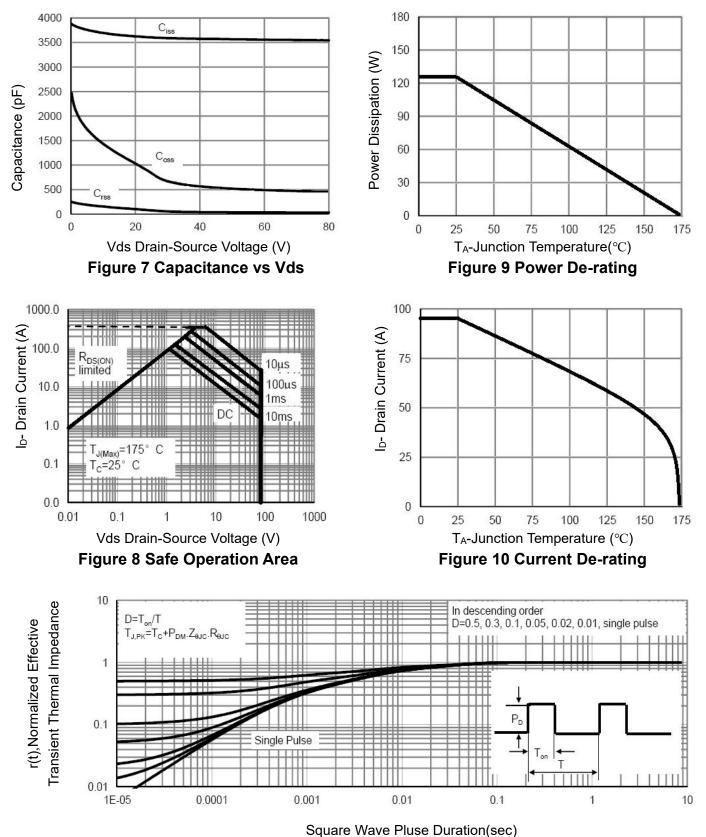
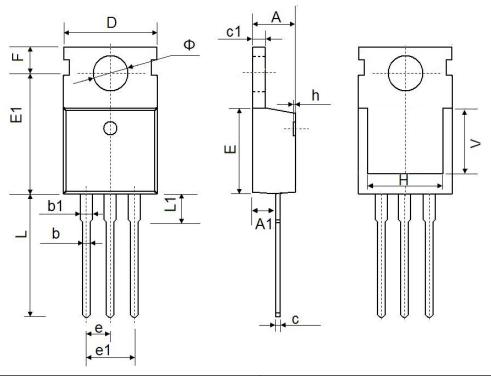


Figure 11 Normalized Maximum Transient Thermal Impedance



## TO-220-3L Package Information

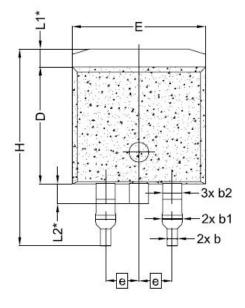


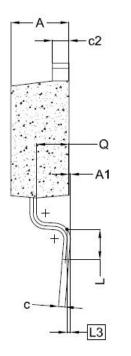
Symbol	Dimensions	In Millimeters	Dimensions In Inches		
Symbol	Min.	Max.	Min.	Max.	
A	4.400	4.600	0.173	0.181	
A1	2.250	2.550	0.089	0.100	
b	0.710	0.910	0.028	0.036	
b1	1.170	1.370	0.046	0.054	
С	0.330	0.650	0.013	0.026	
c1	1.200	1.400	0.047	0.055	
D	9.910	10.250	0.390	0.404	
E	8.9500	9.750	0.352	0.384	
E1	12.650	12.950	0.498	0.510	
е	2.540	0 TYP. 0.1		TYP.	
e1	4.980	5.180	0.196	0.204	
F	2.650	2.950	0.104	0.116	
Н	7.900	8.100	0.311	0.319	
h	0.000	0.300	0.000	0.012	
L	12.900	13.400	0.508	0.528	
L1	2.850	3.250	0.112	0.128	
V	7.500	7.500 REF. 0.295 REF.		REF.	
Ф	3.400	3.800	0.134	0.150	

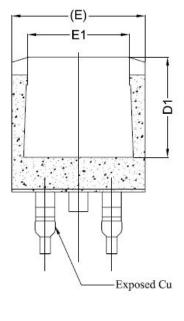


# NCEP058N85M, NCEP058N85MD

## TO-263-2L Package Information







SYMBOL	DIMENSIONS				
STMBOL	MIN,	NOM.	MAX.		
А	4.24	4.44	4.64		
A1	0.00	0.10	0,25		
b	0.70	0.80	0,90		
b1	1.20	1,55	1,75		
b2	1,20	1,45	1,70		
с	0.40	0.50	0.60		
c2	1,15	1,27	1,40		
D	8.82	8.92	9.02		
D1	6.86 7.65				
E	9,96	9.96 10.16			
E1	6.89	7.77	7,89		
е	2.54 BSC				
н	14,61	15,00	15,88		
L	1.78	2.32	2.79		
L1	1.36 REF.				
L2	1.50 REF.				
L3	0.25 BSC				
Q	2,30	2,48	2,70		



Land Pattern (Only for Reference)



#### Attention:

- Any and all NCE power products described or contained herein do not have specifications that can handle applications that require extremely high levels of reliability, such as life-support systems, aircraft's control systems, or other applications whose failure can be reasonably expected to result in serious physical and/or material damage. Consult with your NCE power representative nearest you before using any NCE power products described or contained herein in such applications.
- NCE power assumes no responsibility for equipment failures that result from using products at values that exceed, even momentarily, rated values (such as maximum ratings, operating condition ranges, or other parameters) listed in products specifications of any and all NCE power products described or contained herein.
- Specifications of any and all NCE power products described or contained herein stipulate the performance, characteristics, and functions of the described products in the independent state, and are not guarantees of the performance, characteristics, and functions of the described products as mounted in the customer's products or equipment. To verify symptoms and states that cannot be evaluated in an independent device, the customer should always evaluate and test devices mounted in the customer's products or equipment.
- NCE power Semiconductor CO.,LTD. strives to supply high-quality high-reliability products. However, any and all semiconductor products fail with some probability. It is possible that these probabilistic failures could give rise to accidents or events that could endanger human lives, that could give rise to smoke or fire, or that could cause damage to other property. When designing equipment, adopt safety measures so that these kinds of accidents or events cannot occur. Such measures include but are not limited to protective circuits and error prevention circuits for safe design, redundant design, and structural design.
- In the event that any or all NCE power products(including technical data, services) described or contained herein are controlled under any of applicable local export control laws and regulations, such products must not be exported without obtaining the export license from the authorities concerned in accordance with the above law.
- No part of this publication may be reproduced or transmitted in any form or by any means, electronic or mechanical, including photocopying and recording, or any information storage or retrieval system, or otherwise, without the prior written permission of NCE power Semiconductor CO.,LTD.
- Information (including circuit diagrams and circuit parameters) herein is for example only; it is not guaranteed for volume production. NCE power believes information herein is accurate and reliable, but no guarantees are made or implied regarding its use or any infringements of intellectual property rights or other rights of third parties.
- Any and all information described or contained herein are subject to change without notice due to product/technology improvement, etc. When designing equipment, refer to the "Delivery Specification" for the NCE power product that you intend to use.
- This catalog provides information as of Sep.2010. Specifications and information herein are subject to change without notice.